

## FCT Special Materials

<i>FCT-Denotation</i>	<b>Tantalum Carbide</b>	<b>Titanium Carbide</b>	<b>Titanium Boride</b>	<b>Boron Carbide</b>
Process	Vacuum Sintered / Hot Pressed	Vacuum Sintered / Hot Pressed	Vacuum Sintered / Hot Pressed	Vacuum Sintered / Hot Pressed
Color	<b>Golden</b>	<b>Silver</b>	<b>Greyish Black</b>	<b>Greyish Black</b>
Geometry	Three-Dimensional / Planar Components	Three-Dimensional / Planar Components	Three-Dimensional / Planar Components	Three-Dimensional / Planar Components
Maximum size	On Request	On Request	On Request	On Request
Application	Mechanical Engineering, Solar and Semiconductor Technology, Chemical Plant Engineering and Construction, Air and Space Applications, Jewelry	Mechanical Engineering, Solar and Semiconductor Technology, Air and Space Applications, Jewelry	Mechanical Engineering, Chemical Plant Engineering and Construction, Wear Protection	Mechanical Engineering, Chemical Plant Engineering and Construction, Wear Protection
<b>General Properties</b>				
Chemical Composition	100 % TaC	100 % TiC	100 % TiB <sub>2</sub>	97 % B <sub>4</sub> C
Sinter Additives / Fibre Content	-	-	-	3 % C
Density $\rho$ [1] (%)	14.1 – 14.3	4.75 – 4.90	4.3 – 4.5	2.45 – 2.52
Residual Porosity (%)	On Specific Demand	On Specific Demand	On Specific Demand	On Specific Demand
Open Porosity Thereof (%)	On Specific Demand	On Specific Demand	On Specific Demand	On Specific Demand
Grain Size (Length) ( $\mu\text{m}$ )	2 – 15	1 – 15	-	-
<b>Mechanical Properties</b>				
Compressive Strength (MPa)	-	-	-	-
Bending Strength $\sigma_{RT}$ [2] (MPa)	400	220	480	500
Weibull-Modulus m	10	-	-	-
Youngs Modulus E (GPa)	510	495	540	410
Hardness HV [3] (GPa)	17	32	33	35 – 40
Fracture Toughness $K_{Ic}$ [4] (MPa <sup>1/2</sup> )	3.5	-	5.0	3.5
Poissons Ratio $\nu$	0.15	0.19	0.33	0.2
<b>Thermal Properties</b>				
Maximum Working Temperatures				
– Inert Atmosphere (°C)	2500	2000	2000	1800
– Oxidising Atmosphere (°C)	600 – 800	600	600	600
Specific Heat Capacity (J/kgK)	190	560	620	-
Thermal Conductivity $\lambda$ (20°C) (W/mK)	22	24	24	28
Coefficient of Thermal Expansion	RT– 1000 °C (10 <sup>-6</sup> K <sup>-1</sup> )	6.3	7.4	7.6
	RT– 250 °C (10 <sup>-6</sup> K <sup>-1</sup> )	-	-	4.6
Thermal Shock Parameter R <sub>1</sub> [5] (K)	106	-	78	174
Thermal Shock Parameter R <sub>2</sub> [6] (W/m)	2328	-	1881	4878
<b>Electrical Properties</b>				
Electrical Conductivity (RT) (10 <sup>6</sup> S/m)	3.3 – 4.5	1.5 – 5	1.1	≤ 0.0002
Dielectric Constant (1 MHz)	-	-	-	-

RT = Room Temperature

[1] Determination of density and porosity according to DIN 623-2

[2] Average value of 4-point bending strength at room temperature according to DIN EN 843-1

[3] Hardness according to DIN EN 843-4

[4] Calculated from crack length derived from Vickers hardness indentation, according to Niihara

[5] Critical temperature difference for an infinite high heat transfer (quenching)

[6] Thermal shock coefficient at finite constant heat transfer (slowly heating)

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The material characteristics listed above are measured at testing samples. They cannot be transferred to components with different size, shape or surface properties. We reserve the right to alter properties within the scope of technical progress or new developments.

Further special materials are available on demand. We also tailor your specific material solution !